

National Semiconductor

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.M368-5.0 and LM368-10 Precision Voltage References

LM368-5.0 and LM368-10 Precision Voltage References

General Description

Features

■ 300 µA operating current
■ Low output impedance

sated voltage reference. The LM368 makes use of thin-film technology enhanced by the discrete laser trimming of resistors to achieve excellent Temperature coefficient (Tempco) of V_{OUT} (as low as 5ppm/°C), along with tight initial tolerance, (as low as 0.02%). The trim scheme is such that individual resistors are cut open rather than being trimmed (partially cut), to avoid resistor drift caused by electromigration in the trimmed area. The LM368 also provides excellent stability vs. changes in input voltage and output current (both sourcing and sinking). This device is available in output voltage options of 5.0V and 10.0V and will operate in both series or shunt mode. Also see the LM368-2.5 data sheet for a 2.5V output. The devices are short circuit proof when sourcing current. A trim pin is made available for fine

trimming of $V_{\mbox{OUT}}$ or for obtaining intermediate values with-

out greatly affecting the Tempco of the device.

The LM368 is a precision, monolithic, temperature-compen-

- Excellent line regulation (.0001%/V typical)
- Single-supply operation
- Externally trimmable
- Low temperature coefficient
- Operates in series or shunt mode
- 10.0V or 5.0V
- Excellent initial accuracy (0.02% typical)



*case connected to V

Order Number LM368YH-10, LM368YH-5.0, LM368H-10, LM368H-5.0 See NS Package Number H08C

Typical Applications Series Regulator





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Shunt Regulator

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TL/H/5522-3



A	bso	lute	Maximum	Ratings	(Note 8)
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Input Voltage (Series Mode)	35V
Reverse Current (Shunt Mode)	50 mA
Power Dissipation	600 mW
Storage Temperature Range	-60°C to +150°C
Operating Temperature Range	
LM368	0°C to +70°C

Soldering Information TO-5 (H) Package, 10 sec. + 300°C See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" (Appendix D) for other methods of soldering surface mount devices.

Electrical Characteristics (Note 1)

	Conditions	LM368			
Parameter		Typical	Tested Limit (Note 2)	Design Limit (Note 3)	Units (Max. unless noted)
V _{OUT} Error		±0.02	±0.1		%
Line Regulation	$(V_{OUT}+3V) \le V_{IN} \le 30V$	±0.0001	±0.0005		%/V
Load Regulation (Note 4)	$\begin{array}{l} 0 \text{ mA} \leq I_{\mbox{SOURCE}} \leq 10 \text{ mA} \\ -10 \text{ mA} \leq I_{\mbox{SINK}} \leq 0 \text{ mA} \end{array}$	${\pm0.0003} \\ {\pm0.003}$	±0.001 ±0.008		%/mA %/mA
Thermal Regulation	T=20 mS (Note 5)	±0.005	±0.01		%/100 mW
Quiescent Current		250	350		μΑ
Change of Quiescent Current vs. VIN	$(V_{OUT} + 3V) \le V_{IN} \le 30V$	3	5		μA/V
Temperature Coefficient of V _{OUT} (see graph): LM368Y (Note 6) LM368	$\begin{array}{l} 0^{\circ}C \leq T_{A} \leq 70^{\circ}C \\ 0^{\circ}C \leq T_{A} \leq 70^{\circ}C \end{array}$	±11 ±15	±20	±30	ppm/°C ppm/°C
Short Circuit Current	V _{OUT} = 0	30	70	100	mA
Noise: 10.0V: 0.1 - 10Hz 100Hz - 10 KHz 6.2V: 0.1 - 10Hz 100Hz - 10 kHz 5.0V: 0.1 - 10Hz 100Hz - 10 kHz		30 1100 20 700 16 575			uVp-p nV/√Hz uVp-p nV/√Hz uVp-p nV/√Hz
V _{OUT} Adjust Range: 10.000V 5.000V	$0V \le V_{PIN5} \le V_{OUT}$	4.5-17.0 4.4-7.0		6.0-15.5 4.5-6.0	V min. V min.

Note 1: Unless otherwise noted, these specifications apply: $T_A = 25^{\circ}C$, $V_{IN} = 15V$, $I_{LOAD} = 0$, $0 \le C_L \le 200 \text{ pF}$, Circuit is operating in Series Mode. Or, circuit is operating in Shunt Mode, $V_{IN} = +15V$ or $V_{IN} = V_{OUT}$, $TA = +25^{\circ}C$, $I_{LOAD} = -1.0 \text{ mA}$, $0 \le C_L \le 200 \text{ pF}$.

Note 2: Tested Limits are guaranteed and 100% tested in production.

Note 3: Design Limits are guaranteed (but not 100% production tested) over the indicated temperature and supply voltage ranges. These limits are not used to calculate outgoing quality levels.

Note 4: The LM368 has a Class B output, and will exhibit transients at the crossover point. This point occurs when the device is asked to sink approximately 120 μ A. In some applications it may be advantageous to preload the output to either V_{IN} or Ground, to avoid this crossover point.

Note 5: Thermal Regulation is defined as the change in the output Voltage at a time T after a step change in power dissipation of 100 mW.

Note 6: Temperature Coefficient of V_{OUT} is defined as the worst case delta-V_{OUT} measured at Specified Temperatures divided by the total span of the Specified Temperature Range (See graphs). There is no guarantee that the Specified Temperatures are exactly at the minimum or maximum deviation. **Note 7:** In metal can (H), θ_{J-C} is 75°C/W and θ_{J-A} is 150°C/W.

Note 8: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. DC and AC electrical specifications do not apply when operating the device beyond its Rated Operating Conditions (see Note 1 and Conditions).













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